DESCRIPTION

The SPN4346 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application, notebook computer power management and other battery powered circuits where high-side switching.

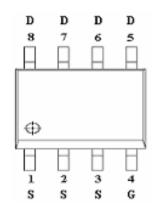
FEATURES

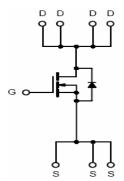
- 30V/6.8A,RDS(ON)= $26m\Omega$ @VGS= 10V
- 30V/6.0A, RDS(ON)= $34m\Omega(a)V$ GS= 4.5V
- 30V/5.6A, RDS(ON)= $40m\Omega$ @VGS= 2.5V
- Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ♦ SOP 8P package design

APPLICATIONS

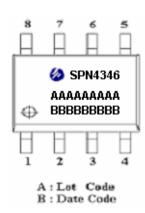
- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOP – 8P)





PART MARKING



PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN4346S8RG	SOP- 8P	SPN4346
SPN4346S8TG	SOP- 8P	SPN4346

※ SPN4346S8RG: 13" Tape Reel; Pb − Free

※ SPN4346S8TG: Tube; Pb − Free

ABSOULTE MAXIMUM RATINGS

(Ta=25°C Unless otherwise noted)

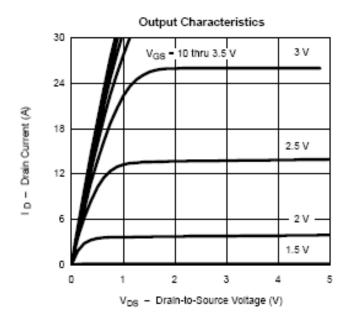
Parameter	Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	30	V
Gate –Source Voltage		VGSS	±12	V
Continuous Drain Current(T _J =150°C)	TA=25°C	ID	6.8	А
Continuous Diam Current(13–130 C)	TA=70°C	ID	5.6	A
Pulsed Drain Current		Ірм	30	А
Continuous Source Current(Diode Conduction)		Is	2.3	А
Dawar Dissination	TA=25°C	Dr	2.5	W
Power Dissipation	Ta=70°C	PD	1.6	W
Operating Junction Temperature		TJ	-55/150	$^{\circ}\mathbb{C}$
Storage Temperature Range		Tstg	-55/150	$^{\circ}\!\mathbb{C}$
Thermal Resistance-Junction to Ambient		RθJA	80	°C/W

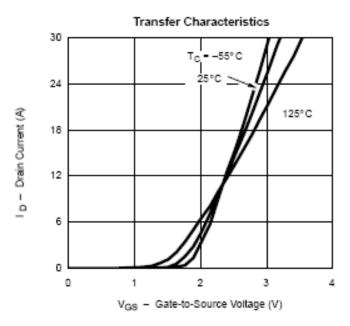
ELECTRICAL CHARACTERISTICS

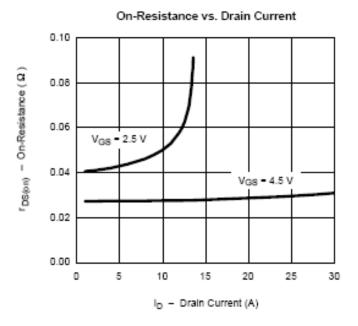
(TA=25°C Unless otherwise noted)

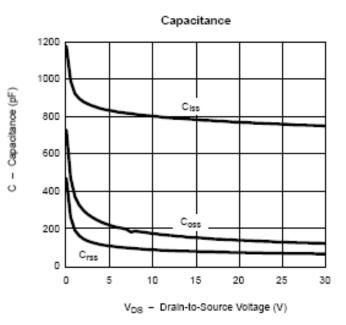
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static	•		•		•	•	
Drain-Source Breakdown Voltage	V(BR)DSS	V _{GS} =0V,I _D =250uA	30			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.8		1.6] v	
Gate Leakage Current	Igss	V _{DS} =0V,V _{GS} =±12V			±100	nA	
		V _{DS} =24V,V _{GS} =0V			1		
Zero Gate Voltage Drain Current	Idss	V _{DS} =24V,V _{GS} =0V T _J =85°C			5	uA	
On-State Drain Current	ID(on)	$V_{DS} \ge 5V, V_{GS} = 10V$	25			A	
		V _G s= 10V,I _D =6.8A		0.018	0.026	Ω	
Drain-Source On-Resistance	RDS(on)	Vgs=4.5V,Id=6.0A		0.024	0.034		
		V _{GS} =2.5V,I _D =5.6A		0.036	0.040		
Forward Transconductance	gfs	VDS=15V,ID=6.2A		13		S	
Diode Forward Voltage	Vsd	Is=2.3A,VGS =0V		0.8	1.2	V	
Dynamic							
Total Gate Charge	Qg			16	24	nC	
Gate-Source Charge	Qgs	V _{DS} =15V,V _{GS} =10V I _D = 2A		3			
Gate-Drain Charge	Qgd	-1D -2/1		2.5			
Turn-On Time	td(on)			15	20	nS	
Turn-On Time	tr	V _{DD} =15V,R _L =15Ω		6	12		
T Off Time	td(off)	$I_{D}\equiv 1.0A, V_{GEN}=10V$ $R_{G}=6\Omega$		10	20		
Turn-Off Time	tf			40	80		

TYPICAL CHARACTERISTICS

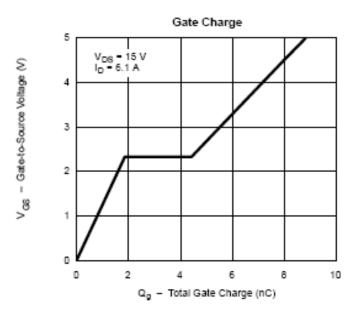


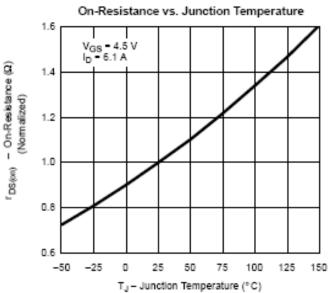


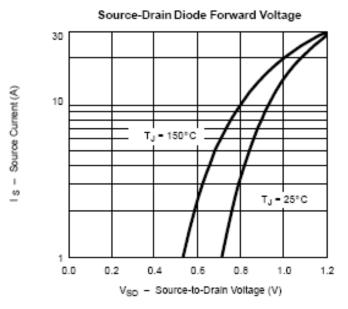


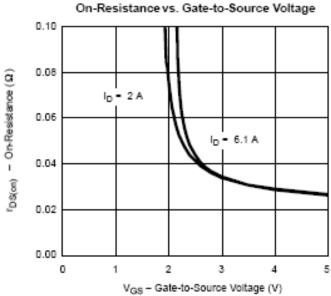


TYPICAL CHARACTERISTICS

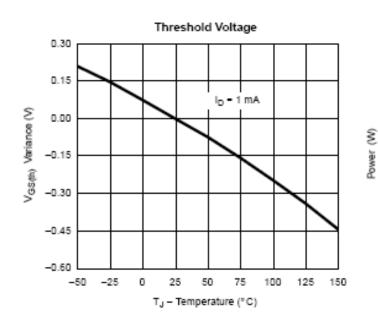


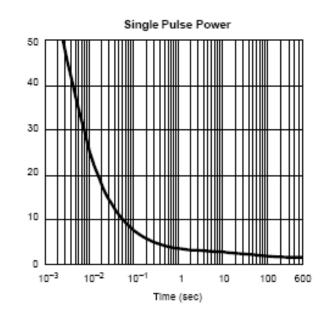


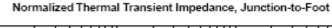


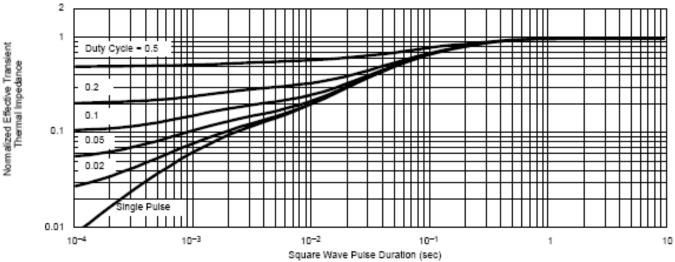


TYPICAL CHARACTERISTICS



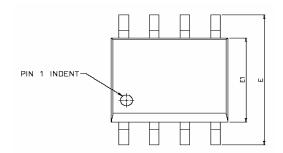


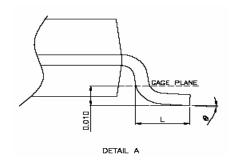


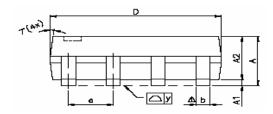


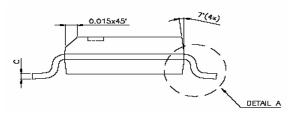


SOP- 8 PACKAGE OUTLINE









DIMENSIONS IN MILLIMETERS		DIMENSIONS IN INCHES				
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10		0.25	0.004		0.010
A2		1.45			0.057	
Ь	0.33	0.41	0.51	0.013	0.016	0.020
С	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
Е	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е	_	1.27	_		0.050	
L	0.38	0.71	1.27	0.015	0.028	0.050
<u>∕</u> 2∖ y			0.076			0.003
0	0°	_	8*	0,		8*

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